

### **Description**

The VSM3008N uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge .This device is suitable for use as a Battery protection or in other switching application.

### **General Feature**

V<sub>DS</sub> =30V,I<sub>D</sub> =8A

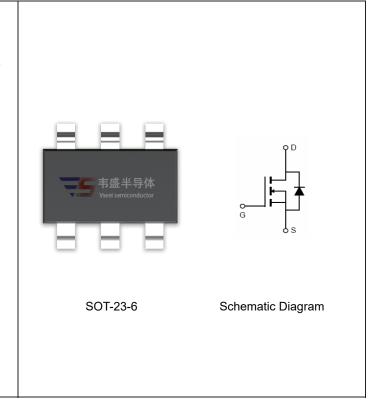
 $R_{DS(ON)}\!<\!15m\Omega$  @  $V_{GS}\!=\!10V$ 

 $R_{DS(ON)}$  < 25m $\Omega$  @  $V_{GS}$ =4.5V

- High Power and current handing capability
- Lead free product is acquired
- Surface mount package

## **Application**

- Battery switch
- DC/DC converter



# **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VSM3008N-S6	VSM3008N	SOT-23-6	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T<sub>A</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	30	V	
Gate-Source Voltage	V <sub>G</sub> S	±20	V	
Drain Current-Continuous	I <sub>D</sub>	8	А	
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	30	А	
Maximum Power Dissipation	P <sub>D</sub>	1.5	W	
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 150	°C	

#### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2) ReJA 83.3 °C/W
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# **Electrical Characteristics (T<sub>A</sub>=25**°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	30	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V	-	-	1	μA



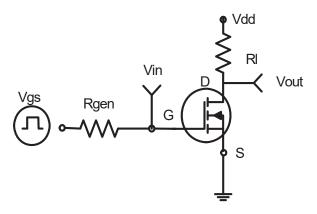
Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20 $V$ , $V_{DS}$ =0 $V$	-	-	±100	nA	
On Characteristics (Note 3)	·						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.2	1.8	2.4	V	
Drain-Source On-State Resistance	В	V <sub>GS</sub> =10V, I <sub>D</sub> =4A	-	13.5	15	mΩ	
Diam-Source On-State Resistance	$R_{DS(ON)}$	V <sub>GS</sub> =4.5V, I <sub>D</sub> =4A	-	19	25	mΩ	
Dynamic Characteristics (Note4)	•		•				
Input Capacitance	C <sub>lss</sub>	\/ -15\/\/ -0\/	-	784	-	PF	
Output Capacitance	Coss	$V_{DS}$ =15V, $V_{GS}$ =0V, F=1.0MHz	-	109.4	-	PF	
Reverse Transfer Capacitance	C <sub>rss</sub>	r-1.0ivinz	-	93.8	-	PF	
Switching Characteristics (Note 4)	·						
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =15V,I <sub>D</sub> =4A	-	4	-	nS	
Turn-on Rise Time	t <sub>r</sub>		-	9	-	nS	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{GEN}$ =1 $\Omega$	-	17	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	6	-	nS	
Total Gate Charge	Qg	\/ -45\/1 -44	-	19.4	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =15V,I <sub>D</sub> =4A, V <sub>GS</sub> =10V	-	2.5	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>	v <sub>GS</sub> -10v	-	5.0	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =4A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	8	А	

### Notes:

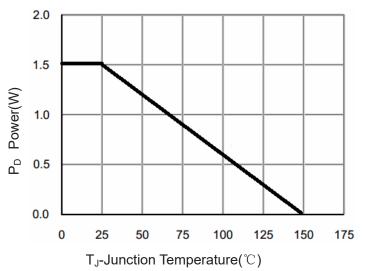
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- **3.** Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- **4.** Guaranteed by design, not subject to production



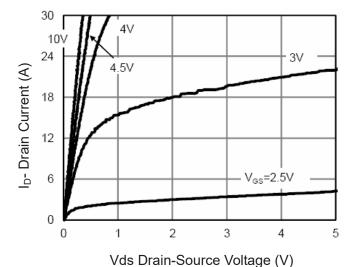
# **Typical Electrical and Thermal Characteristics**



**Figure 1 Switching Test Circuit** 



**Figure 3 Power Dissipation** 



**Figure 5 Output Characteristics** 

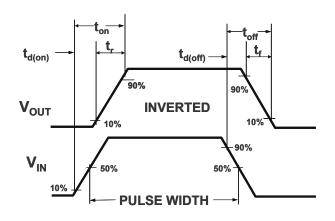
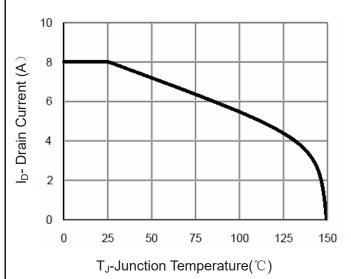


Figure 2 Switching Waveforms



**Figure 4 Drain Current** 

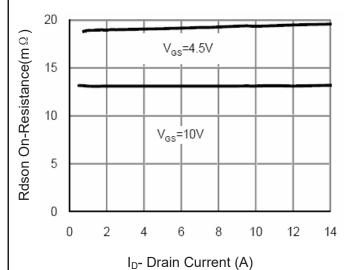
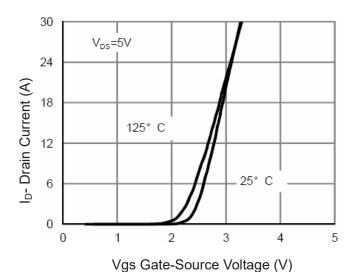
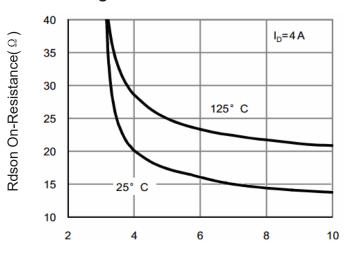


Figure 6 Drain-Source On-Resistance





**Figure 7 Transfer Characteristics** 



Vgs Gate-Source Voltage (V)

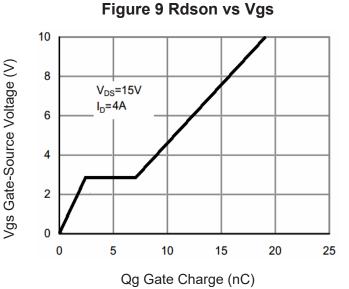


Figure 11 Gate Charge

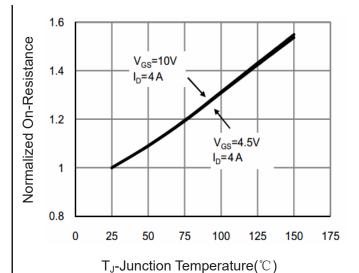
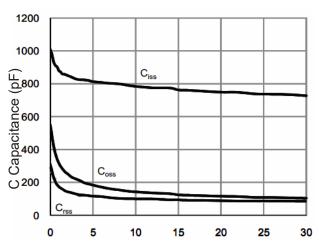
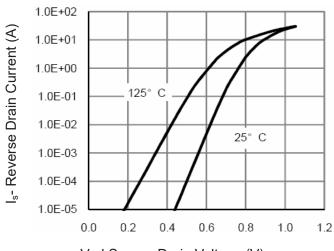


Figure 8 Drain-Source On-Resistance



Vds Drain-Source Voltage (V)

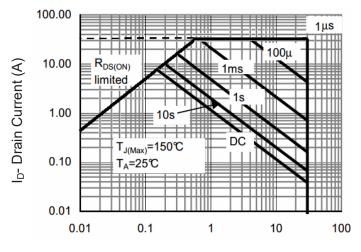
Figure 10 Capacitance vs Vds



Vsd Source-Drain Voltage (V)

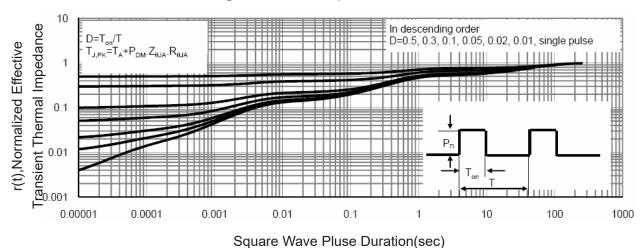
Figure 12 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)

Figure 13 Safe Operation Area



**Figure 14 Normalized Maximum Transient Thermal Impedance**